

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
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EPAS ID: PAT4386512

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	RELEASE OF SECURITY INTEREST
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
BAYVIEW CAPITAL PARTNERS II LP	04/25/2017
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	AERO SYSTEMS ENGINEERING, INC.
<b>Street Address:</b>	358 EAST FILLMORE AVENUE
<b>City:</b>	ST. PAUL
<b>State/Country:</b>	MINNESOTA
<b>Postal Code:</b>	55107
<b>PROPERTY NUMBERS Total: 6</b>	
<b>Property Type</b>	<b>Number</b>
Patent Number:	5505081
Patent Number:	5837890
Patent Number:	5606110
Patent Number:	6725912
Patent Number:	6748800
Patent Number:	7153136
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(615)248-2954
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	615-742-7944
<b>Email:</b>	trademarks@bassberry.com
<b>Correspondent Name:</b>	MARTHA B. ALLARD
<b>Address Line 1:</b>	150 3RD AVENUE SOUTH
<b>Address Line 2:</b>	SUITE 2800
<b>Address Line 4:</b>	NASHVILLE, TENNESSEE 37201
<b>ATTORNEY DOCKET NUMBER:</b>	117100-263
<b>NAME OF SUBMITTER:</b>	MARTHA B. ALLARD
<b>SIGNATURE:</b>	/Martha B. Allard/
<b>DATE SIGNED:</b>	04/26/2017

**Total Attachments: 3**

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## RELEASE OF PATENT SECURITY INTEREST

This **RELEASE OF PATENT SECURITY INTEREST**, dated as of April 25, 2017, is made by Bayview Capital Partners II LP (the "Lender") in favor of Aero Systems Engineering, Inc., a Minnesota corporation ("Borrower").

**WHEREAS**, Roynat Business Capital, Inc., a Delaware corporation ("Roynat") and Borrower, are parties to that certain Note Purchase Agreement dated January 3, 2006 (and as further amended, supplemented or otherwise modified from time to time, the "Note Purchase Agreement");

**WHEREAS**, in connection with the Note Purchase Agreement, the Borrower executed a certain Patent Security Agreement (as amended, restated, supplemented or otherwise modified from time to time, the "Patent Security Agreement"), and granted to the Roynat a security interest in and to all of Borrower's right, title, and interest in certain patents and applications (collectively, the "Patents") to secure the Obligations (as defined in the Note Purchase Agreement);

**WHEREAS**, the Patent Security Agreement was duly recorded on January 4, 2006 at Reel/Frame 016967/0145 in the United States Patent and Trademark Office;

**WHEREAS**, Roynat assigned its interest in and to the Note Purchase Agreement to Lender;

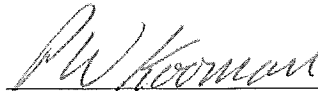
**WHEREAS**, the Lender wishes to release and restore all right, title and interest in and dissolve those liens and encumbrances created by the Patent Security Agreement with respect to the Patents set forth on Schedule A attached hereto (the "Released Patents"),

**NOW, THEREFORE**, for good and valuable consideration, receipt of which is hereby acknowledged, the Lender hereby grants, assigns, and conveys, without recourse or warranty, to the Borrower all of its rights, title, and interest in the Released Patents, and terminates, releases, discharges, quitclaims, and relinquishes unto the Borrower any and all security interests and liens it has against the Released Patents.

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IN WITNESS WHEREOF, Lender has caused this Release of Patent Security Interest to be executed by its duly authorized representative as of the date first above written.

Bayview Capital Partners II LP, as Lender

A handwritten signature in cursive script, appearing to read "P.W. Keorman", is written over a horizontal line.

By: Bayview Capital Management II LLC  
Its: General Partner

**SCHEDULE A  
RELEASED PATENTS**

The following Patents are Released:

- A. United States Patent No. 5,505,081 issued on April 9, 1996 for: Valve Assembly for Free Piston Shock Tube/Tunnel.
- B. France Patent No. 9,510,672 issued on April 16, 1999 for: Valve Assembly for Free Piston Shock Tube/Tunnel.
- C. Japan Patent No. 3,124,043 issued on September 19, 2000 for: Valve Assembly for Free Piston Shock Tube/Tunnel.
- D. United States Patent No. 5,837,890 issued on November 17, 1998 for: Jet Engine Test Cell Structure.
- E. Singapore Patent No. 34,326 issued on April 17, 1997 for: Jet Engine Test Cell Structure.
- F. Taiwan Patent No. 87,207 issued on April 24, 1997 for: Jet Engine Test Cell Structure.
- G. United States Patent No. 5,606,110 issued on February 25, 1997 for: Diaphragm Construction for Free Piston Shock Tube/Tunnel.
- H. United States Patent No. 6,725,912 B1 issued on April 27, 2004 for: Wind Tunnel and Heat Exchanger Therefor.
- I. United States Patent No. 6,748,800 B2 issued on June 15, 2004 for: Wind Tunnel and Heat Exchanger Therefor.
- J. United States Patent No. 7,153,136 issued on December 26, 2006 for: Free Fall Simulator.

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